BK22 Series



Applications













Smartphone & Tablet

Wearables

VR/AR Glass

Introducing the BK22 Series – an ultra-compact hybrid **FPC-to-board connector**

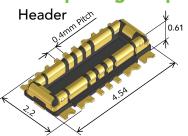
Designed for seamless connectivity in mobile devices, wireless earphones, wearables, and more. With superior mating operability for easy and secure connections, up to 15A power support, and a fully armored robust design, the BK22 ensures dependable performance. Minimized resistance contributes to power savings, while the multi-point contact design enhances overall reliability. Embrace BK22's innovation and redefine your device connectivity.

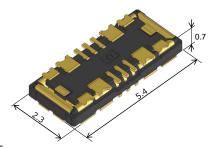
0.4mm Pitch, 0.7mm Stacking Height, 15A Rated Current, Power/Signal Hybrid FPC-to-Board Connector

- Space-saving Design with 15A Rated Current
- Robust Design
- **High Contact Reliability**
- Superior Mating Operability
- Halogen-Free

Dimensions

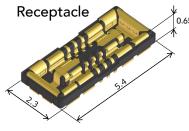
Example: Signal 6pos. +Power 2pos.





Mated Condition

Stacking Height: 0.7mm





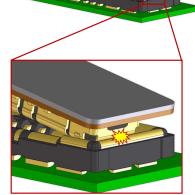
Length

| | 4pos. | 6pos. |
|------------|-------|----------|
| Header | 4.14 | 4.54 |
| Receptacle | 5.0 | 5.4 |
| | | Unit: mm |

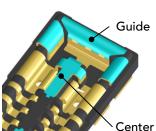
CLICK HERE TO ORDER SAMPLE NUMBER: US-BK22SAMPLE-23

Robust Design

Fully armored design prevents housing damage.



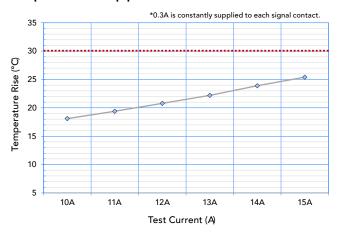






High Power Supply (up to 15A)

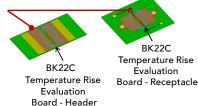
Temperature rise of 30 °C or less when 15A power is applied.



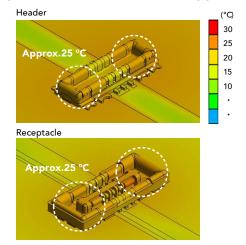
Test Board Specifications:

Pattern Width (Power Contact): 15mm Pattern Width (Signal Contact): 0.3mm

Copper Foil: 35µm



Amount of Temperature Rise of Header and Receptacle when 15A Power is Applied



*Initial Temperature: 20°C

*Temperature Rise Value

- Power Contact : 25.4°C

- Signal Contact: 24.9°C

*Note: For the temperature rise of other pattern widths, please contact your HRS representative.

Specifications

| MATERIAL AND FINISH | | |
|---------------------|--------------|----------------------------------|
| Component | Material | Finish, Remarks |
| Housing | LCP* | Black, UL94V-0 |
| Signal Contact | Copper Alloy | Gold Plated (Nickel Underplated) |
| Power Contact | Copper Alloy | Gold Plated (Nickel Underplated) |
| Retention Tab | Copper Alloy | Gold Plated (Nickel Underplated) |

^{*}This product satisfies halogen free requirements defined as 900ppm maximum chlorine, 900ppm maximum bromine, and 1500ppm maximum total of chlorine and bromine.

| PERFORMANCE CHARACTERISTICS | | |
|-----------------------------|---|--|
| Rated Current | Power : 15A Signal : 0.3A | |
| Rated Voltage | 60V AC/DC | |
| Operating Temperature | -55 to +85° C | |
| Contact Resistance | Power Contact : $5m\Omega$ Max. Signal Contact : $30m\Omega$ Max. | |
| Withstanding Voltage | 150V AC for 1 min. | |
| Insulation Resistance | 50M Min. (100V DC) | |
| Mating Durability | 10 times | |

- No. of Pos.: 4 and 6pos.

*Includes the temperature rise due to current flow.

